ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES INDUSTRIES INDUSTRIES	C, Bannockb	urn, Illinois. A	ll rights reserved untions.	inder both	This docum level parts,	ent is a declarat	ion of the su	ibstances s all lowe	within the manufactur r level materials for w	rer listed	item. Note: i manufacture	f the item is an as r has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distri				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials				ials and N	s and Mfg Information				
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority				Response Date*				
onsemi										2024-0	2024-05-02			
Contact Name Title - Contact			itact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Env			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			resentative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product En			ct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	version	1	Manufacturing Site		Weight*	UOM	Unit Type	
	SZNUF4	402MNT1G	MI 4 CH EMI FILTER DFN 8L			2024-05-02		1	MY1		10.01	mg	Each	
Manufacturing Proccess Informati	on													
Terminal Plating / Grid Array Mate	Iaterial Terminal Base		Alloy	y J-STD-020 MSL Ra		Peak Proc	Process Body Temperatur		re Max Time at Peak	Tempera	ture Numb	per of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	-	1		260		С	30	seco	nds 3			
Comments														
level 1 - maximum time at peak temperatur	e during sol	dering is 10-3	0 seconds											
For more information regarding material c	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe ve independently verified such information. How heir contributions to the part, and those certifica anditions of that agreement, including any warr	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	garding their contributions to the part, and those certifications are at least as comprehensive as the ms and conditions of that agreement, including any warranty rights and/or remedies provided as part of ing information the Supplier provides in this form. In the absence of such written agreement, the   Supplier Acceptance * Accepted   exemptions, then select the corresponding response in the RoHS Declaration above and choose all							
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg
Die Attach	0.24	mg	Supplier	Silver (Ag)	7440-22-4		0.18	mg
			Supplier	Epoxy resins	129915-35-1		0.06	mg
Lead Frame	3.71	mg	Supplier	Silver (Ag)	7440-22-4		0.6826	mg
			Supplier	Iron (Fe)	7439-89-6		0.0297	mg
			Supplier	Copper (Cu)	7440-50-8		2.9977	mg
Mold Compound-Black	5.0	mg		Epoxy resin	proprietary data		0.35	mg
				Phenolic Resin	Proprietary Data		0.35	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.75	mg
			Supplier	Carbon Black (C)	1333-86-4		0.025	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.525	mg
Plating	0.29	mg	Supplier	Tin (Sn)	7440-31-5		0.29	mg
Wire Bond - Au	0.67	mg	Supplier	Gold (Au)	7440-57-5		0.67	mg